

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hidetoshi Komatsu	07/22/2008
Kazuto Ohyama	07/22/2008
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Koganei Corporation
<b>Street Address:</b>	8-16, Iwamotocho 3-chome, Chiyoda-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	101-0032
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12162621
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(860)527-0464
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Email:</b>	rounds@ip-lawyers.com
<b>Correspondent Name:</b>	J. Linderman; McCormick Paulding Huber
<b>Address Line 1:</b>	185 Asylum Street, CityPlace II
<b>Address Line 4:</b>	Hartford, CONNECTICUT 06103
<b>ATTORNEY DOCKET NUMBER:</b>	4724-0056WOUS
<b>NAME OF SUBMITTER:</b>	John C. Linderman
<b>Total Attachments: 2</b> source=47240056WOUSpassign#page1.tif source=47240056WOUSpassign#page2.tif	

CH \$40.00 12162621

ASSIGNMENT

THIS INSTRUMENT OF ASSIGNMENT WITNESSETH THAT:

WHEREAS, we, Hidetoshi KOMATSU and Kazuto OHYAMA  
residents of  
Koganei Corporation of 8-16, Iwamotocho 3-chome, Chiyoda-ku, Tokyo 101-0032, Japan  
respectively, have invented improvements in

## MACHINING TOOL AND MACHINING METHOD

for which we have executed on even date herewith an application for Letters Patent of the  
United States, and

WHEREAS, Koganei Corporation  
a corporation of the Japan  
having a place of business at 8-16, Iwamotocho 3-chome, Chiyoda-ku, Tokyo 101-0032,  
Japan  
is desirous of acquiring an interest in said invention, said application and the Letters Patent  
to be issued therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for and  
in consideration of the sum of ONE DOLLAR to each in hand paid and other good and  
valuable consideration, the receipt whereof is hereby acknowledged, we have sold, assigned  
and set over, and do hereby sell, assign and set over to said corporation, its successors or  
assigns, the entire right, title and interest to and in said invention in the United States and in  
all foreign countries, said United States application for Letters Patent therefor and the  
Letters Patent when issued; and we do hereby authorize and request the Commissioner of  
Patent and Trademarks to issue the Letters Patent based upon said application to said  
corporation as the assignees of our entire right, title and interest to and in the same, for the  
sole use and behoof of said corporation, its successors or assigns.

And we also hereby covenant and agree to sign all proper papers including  
divisional and other applications for patents and assignments thereof in the United States  
and application for patents and assignments in all foreign countries, and to execute all

rightful oaths and to take any other proper action that may in the judgment of the said corporation be necessary for securing thereto full rights to said invention, all of the foregoing to be at the expense of said corporation.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals.

July 22, 2008  
Date

By Hidetoshi Komatsu  
Hidetoshi KOMATSU

July 22, 2008  
Date

By Kazuto Ohyama  
Kazuto OHYAMA